

Product Summary

Device	BV _{DSS}	R _{D(S)} Max	I _D Max T _A = +25°C
Q1	60V	1.7Ω @ V _{GS} = 10V	571mA
		3Ω @ V _{GS} = 4.5V	430mA
Q2	-50V	6Ω @ V _{GS} = -10V	-304mA
		8Ω @ V _{GS} = -5V	-263mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

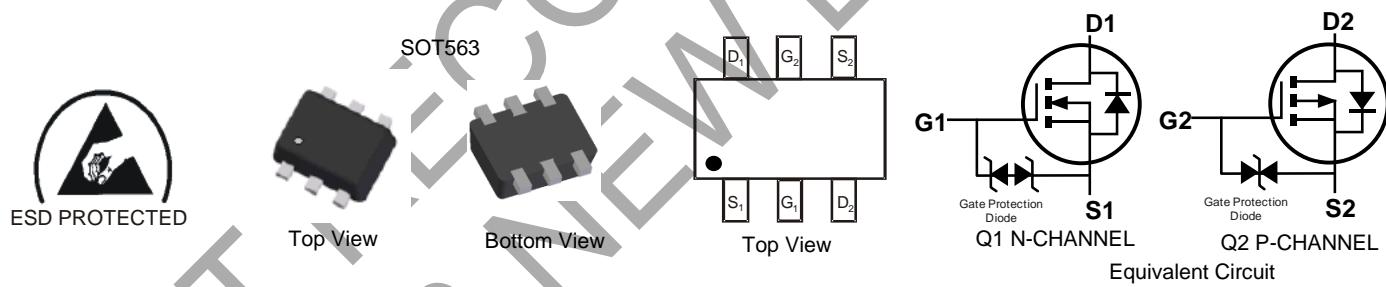
- Power Management Functions
- DC-DC Converters
- Battery

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.003 grams (Approximate)



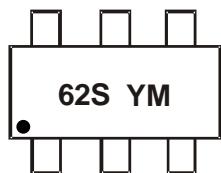
Ordering Information (Note 5)

Part Number	Case	Packaging
DMC62D0SVQ-7	SOT563	3,000/Tape & Reel
DMC62D0SVQ-13	SOT563	10,000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/product-compliance-definitions/>.
5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



62S = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: E = 2017)
 M = Month (ex: 9 = September)

Date Code Key

Year	2016	2017	2018	2019	2020	2021	2022					
Code	D	E	F	G	H	I	J					
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Q1_Value	Q2_Value	Unit
Drain-Source Voltage	V_{DSS}	60	-50	V
Gate-Source Voltage	V_{GSS}	± 20	± 20	V
Continuous Drain Current (Note 7) N-Channel: $V_{GS} = 10\text{V}$ P-Channel: $V_{GS} = -10\text{V}$	Steady State $T_A = +25^\circ\text{C}$ $T_A = +70^\circ\text{C}$	I_D 571 457	-304 -243	mA
Pulsed Drain Current (10 μs Pulse, Duty Cycle = 1%)	I_{DM}	1,200	-800	mA
Maximum Body Diode Continuous Current (Note 7)	I_S	500	-300	mA

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	P_D	0.51	W
Thermal Resistance, Junction to Ambient (Note 6)	R_{JJA}	250	°C/W
Total Power Dissipation (Note 7)	P_D	0.84	W
Thermal Resistance, Junction to Ambient (Note 7)	R_{JJA}	150	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Notes:
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

Electrical Characteristics - Q1 N-CHANNEL (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV_{DSS}	60	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}$, $\text{I}_D = 250\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1	μA	$\text{V}_{\text{DS}} = 60\text{V}$, $\text{V}_{\text{GS}} = 0\text{V}$
Gate-Source Leakage	I_{GSS}	—	—	± 10	μA	$\text{V}_{\text{GS}} = \pm 20\text{V}$, $\text{V}_{\text{DS}} = 0\text{V}$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{TH})}$	1.0	—	2.5	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}$, $\text{I}_D = 250\mu\text{A}$
Static Drain-Source On-Resistance	$\text{R}_{\text{DS}(\text{ON})}$	—	—	1.7	Ω	$\text{V}_{\text{GS}} = 10\text{V}$, $\text{I}_D = 500\text{mA}$
		—	—	3		$\text{V}_{\text{GS}} = 4.5\text{V}$, $\text{I}_D = 200\text{mA}$
Diode Forward Voltage	V_{SD}	—	—	1.4	V	$\text{V}_{\text{GS}} = 0\text{V}$, $\text{I}_S = 115\text{mA}$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C_{iss}	—	30	—	pF	$\text{V}_{\text{DS}} = 25\text{V}$, $\text{V}_{\text{GS}} = 0\text{V}$, $f = 1.0\text{MHz}$
Output Capacitance	C_{oss}	—	4.2	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	2.9	—	pF	
Total Gate Charge	Q_g	—	0.4	—	nC	$\text{V}_{\text{GS}} = 4.5\text{V}$, $\text{V}_{\text{DS}} = 10\text{V}$, $\text{I}_D = 250\text{mA}$
Gate-Source Charge	Q_{gs}	—	0.15	—	nC	
Gate-Drain Charge	Q_{gd}	—	0.09	—	nC	
Turn-On Delay Time	$\text{t}_{\text{D}(\text{ON})}$	—	4.3	—	ns	$\text{V}_{\text{DD}} = 30\text{V}$, $\text{V}_{\text{GS}} = 10\text{V}$, $\text{R}_g = 25\Omega$, $\text{I}_D = 200\text{mA}$
Turn-On Rise Time	t_R	—	2.7	—	ns	
Turn-Off Delay Time	$\text{t}_{\text{D}(\text{OFF})}$	—	15.1	—	ns	
Turn-Off Fall Time	t_F	—	6.5	—	ns	

 Electrical Characteristics - Q2 P-CHANNEL (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV_{DSS}	-50	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}$, $\text{I}_D = -250\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	-1	μA	$\text{V}_{\text{DS}} = -50\text{V}$, $\text{V}_{\text{GS}} = 0\text{V}$
Gate-Source Leakage	I_{GSS}	—	—	± 10	μA	$\text{V}_{\text{GS}} = \pm 16\text{V}$, $\text{V}_{\text{DS}} = 0\text{V}$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{TH})}$	-1	—	-2.5	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}$, $\text{I}_D = -250\mu\text{A}$
Static Drain-Source On-Resistance	$\text{R}_{\text{DS}(\text{ON})}$	—	—	6	Ω	$\text{V}_{\text{GS}} = -10\text{V}$, $\text{I}_D = -500\text{mA}$
		—	—	8		$\text{V}_{\text{GS}} = -5\text{V}$, $\text{I}_D = -200\text{mA}$
Diode Forward Voltage	V_{SD}	—	—	-1.4	V	$\text{V}_{\text{GS}} = 0\text{V}$, $\text{I}_S = -115\text{mA}$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C_{iss}	—	26	—	pF	$\text{V}_{\text{DS}} = -25\text{V}$, $\text{V}_{\text{GS}} = 0\text{V}$, $f = 1.0\text{MHz}$
Output Capacitance	C_{oss}	—	4.2	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	2.4	—	pF	
Total Gate Charge	Q_g	—	0.3	—	nC	$\text{V}_{\text{GS}} = -4.5\text{V}$, $\text{V}_{\text{DS}} = -10\text{V}$, $\text{I}_D = -500\text{mA}$
Gate-Source Charge	Q_{gs}	—	0.14	—	nC	
Gate-Drain Charge	Q_{gd}	—	0.12	—	nC	
Turn-On Delay Time	$\text{t}_{\text{D}(\text{ON})}$	—	4.1	—	ns	$\text{V}_{\text{DD}} = -30\text{V}$, $\text{V}_{\text{GS}} = -10\text{V}$, $\text{R}_g = 50\Omega$, $\text{I}_D = -270\text{mA}$
Turn-On Rise Time	t_R	—	2.8	—	ns	
Turn-Off Delay Time	$\text{t}_{\text{D}(\text{OFF})}$	—	20.2	—	ns	
Turn-Off Fall Time	t_F	—	9.15	—	ns	

Notes: 8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

Typical Characteristics - N-CHANNEL

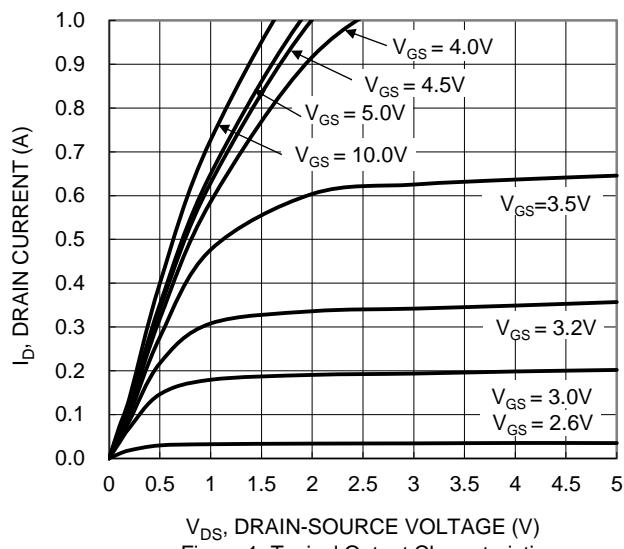


Figure 1. Typical Output Characteristic

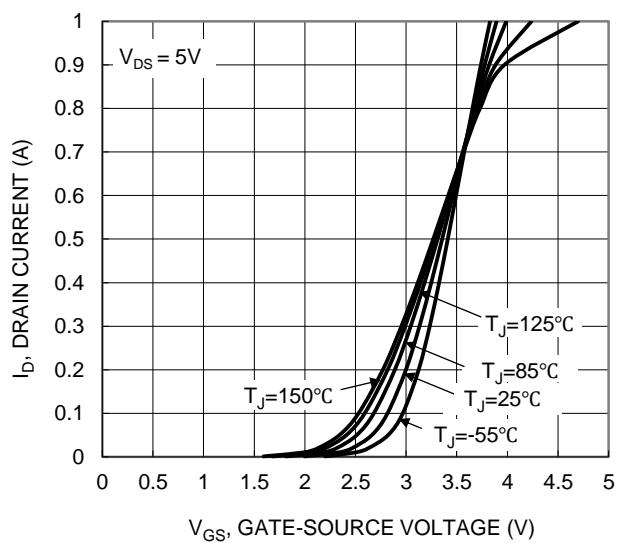


Figure 2. Typical Transfer Characteristic

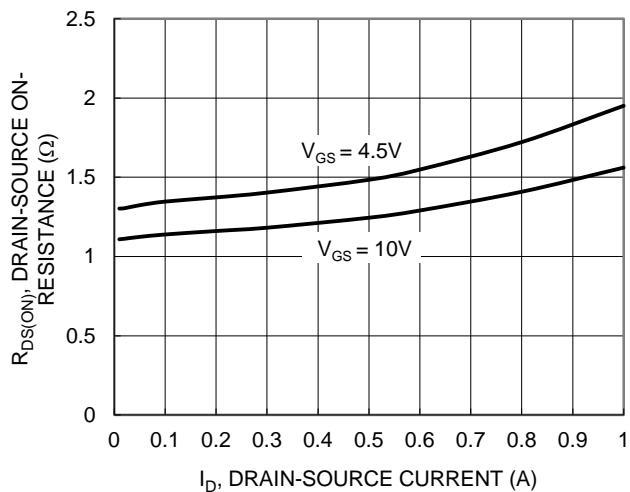


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

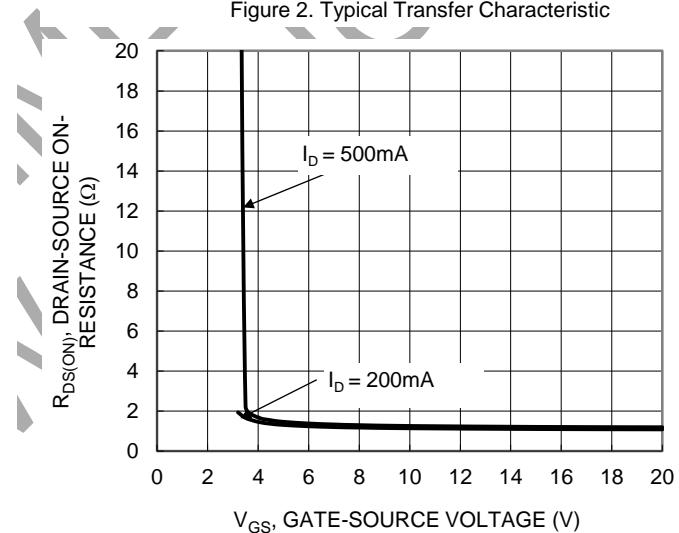


Figure 4. Typical Transfer Characteristic

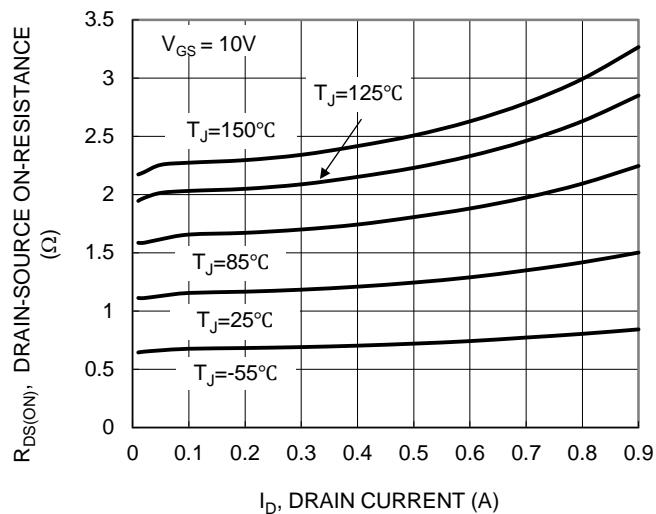


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

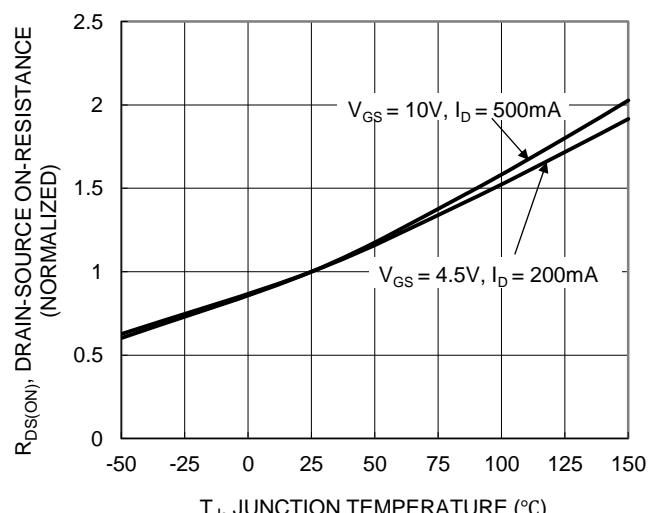
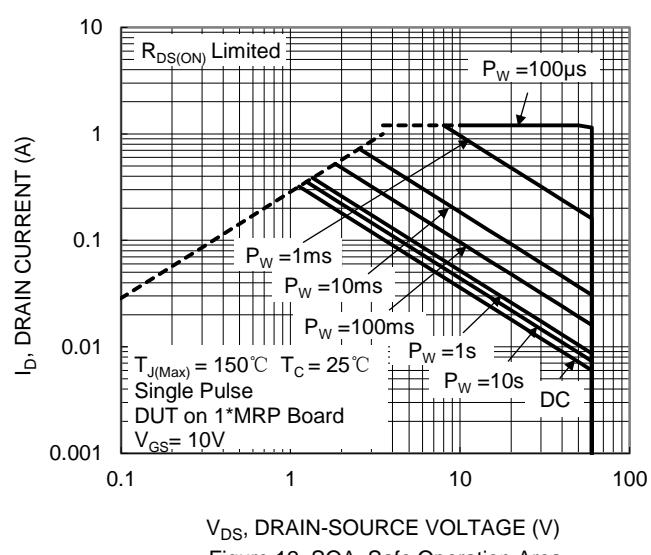
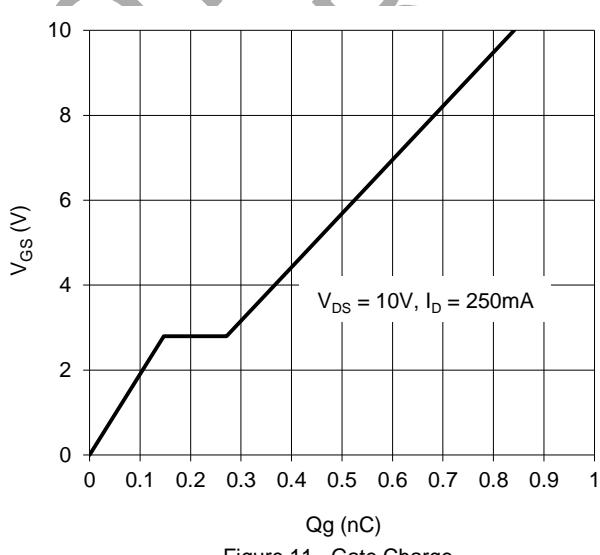
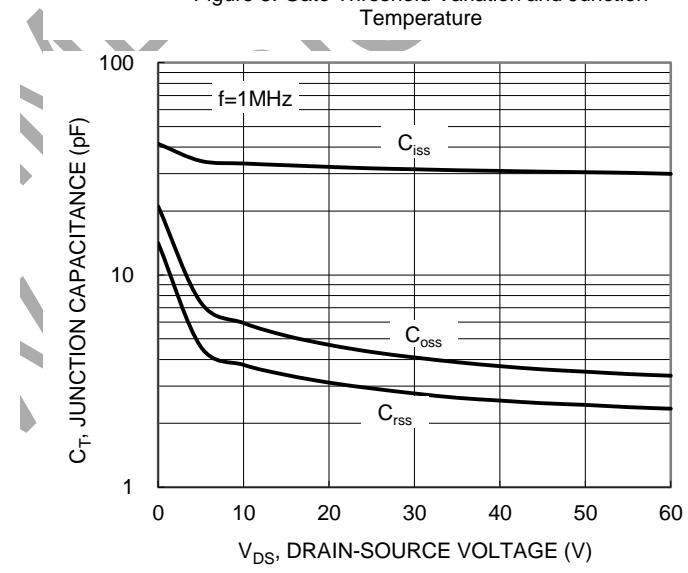
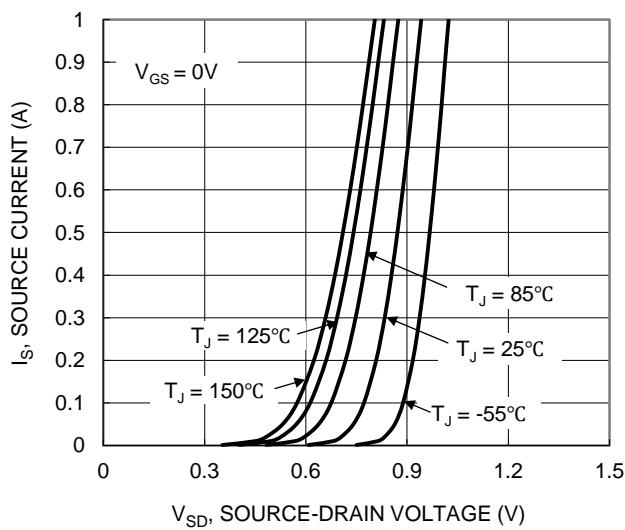
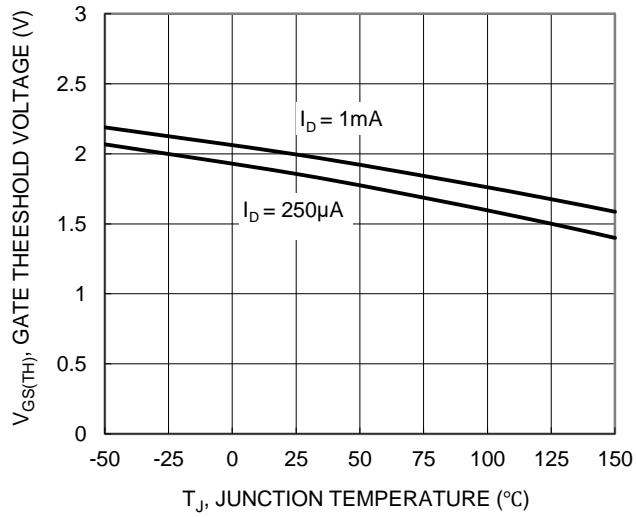
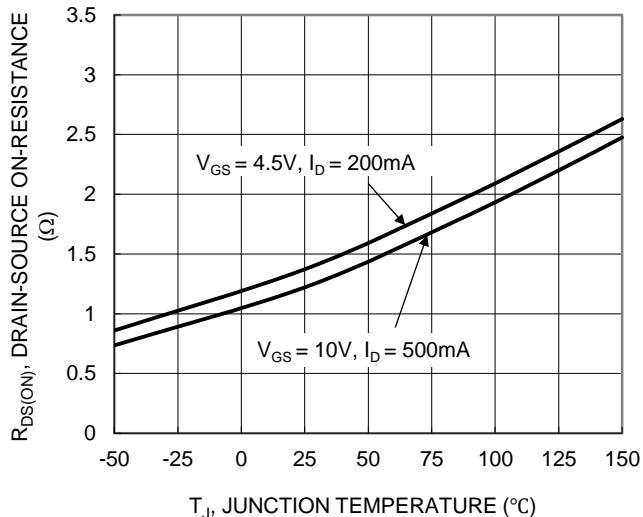


Figure 6. On-Resistance Variation with Temperature

Typical Characteristics - N-CHANNEL (Cont.)



Typical Characteristics - P-CHANNEL

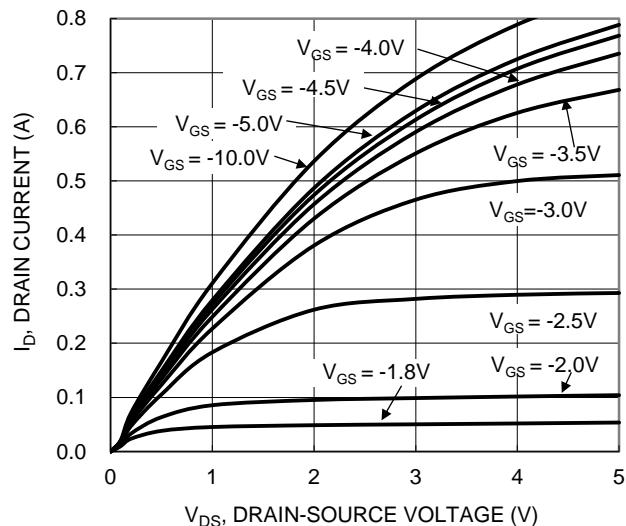


Figure 13. Typical Output Characteristic

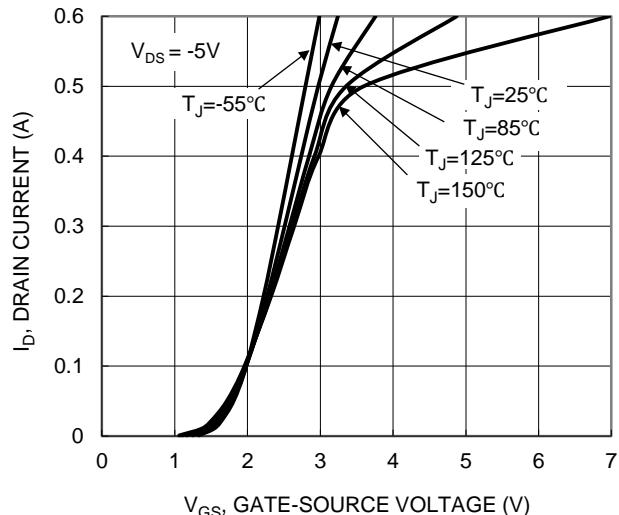


Figure 14. Typical Transfer Characteristic

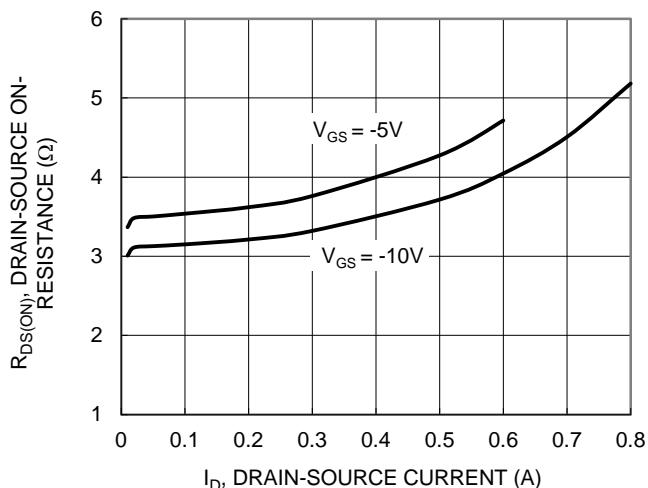


Figure 15. Typical On-Resistance vs. Drain Current and Gate Voltage

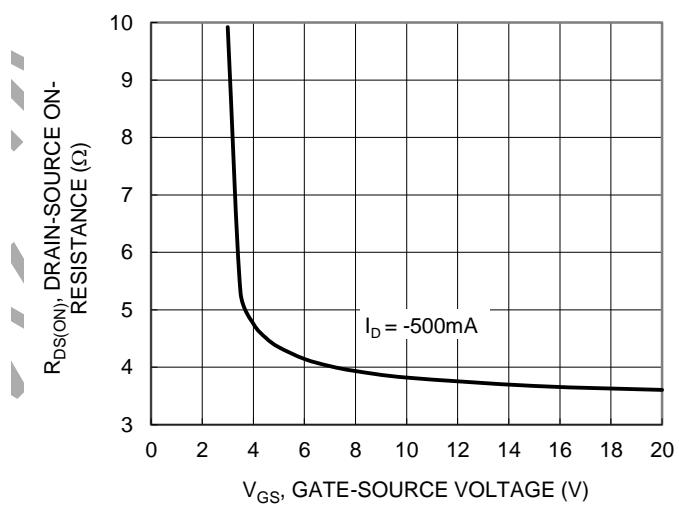


Figure 16. Typical Transfer Characteristic

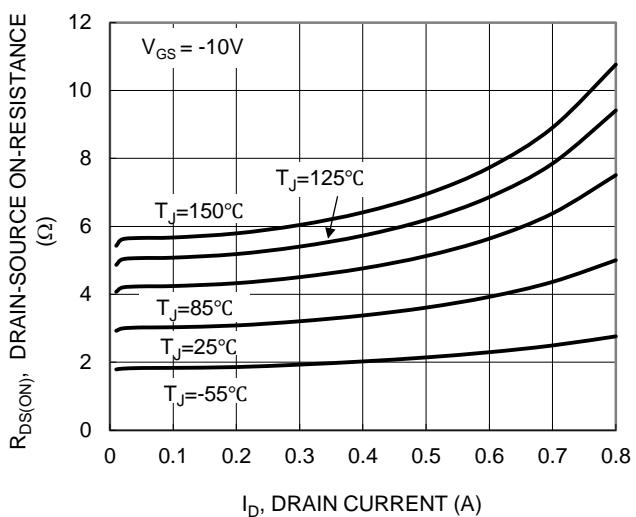


Figure 17. Typical On-Resistance vs. Drain Current and Temperature

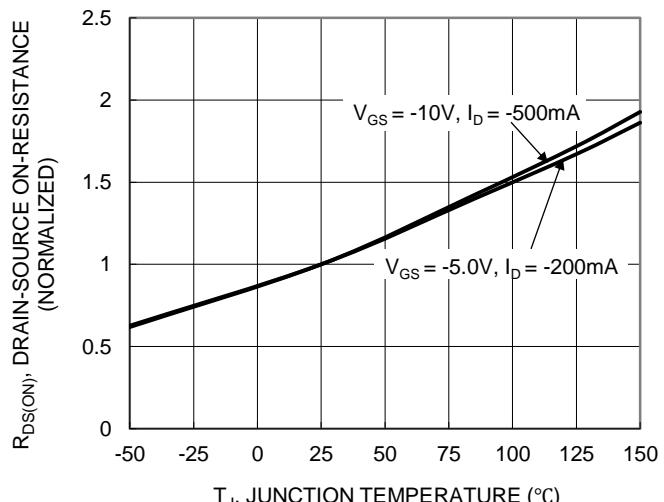
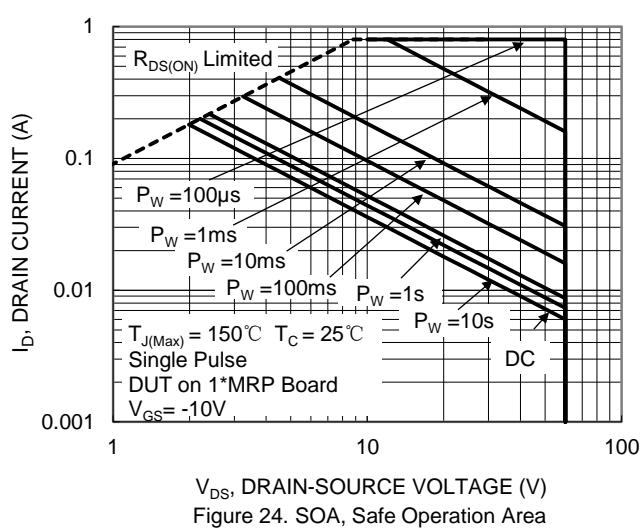
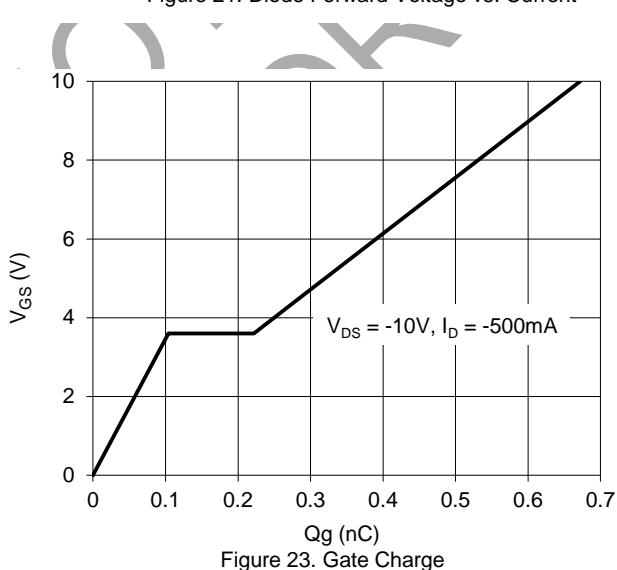
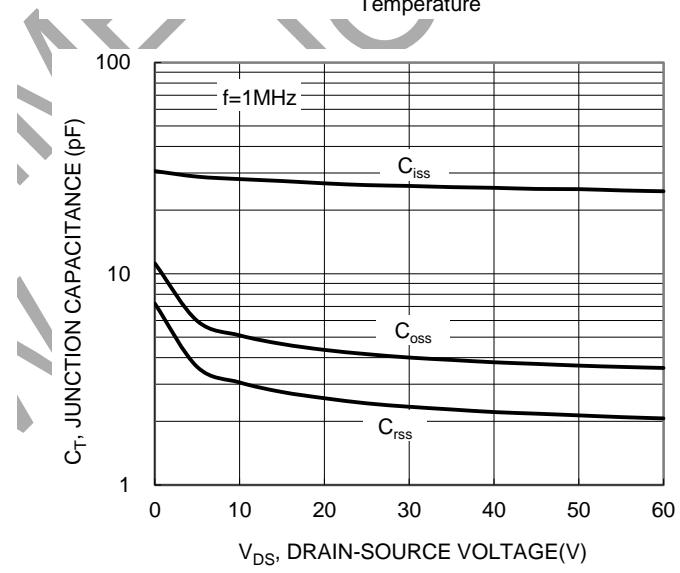
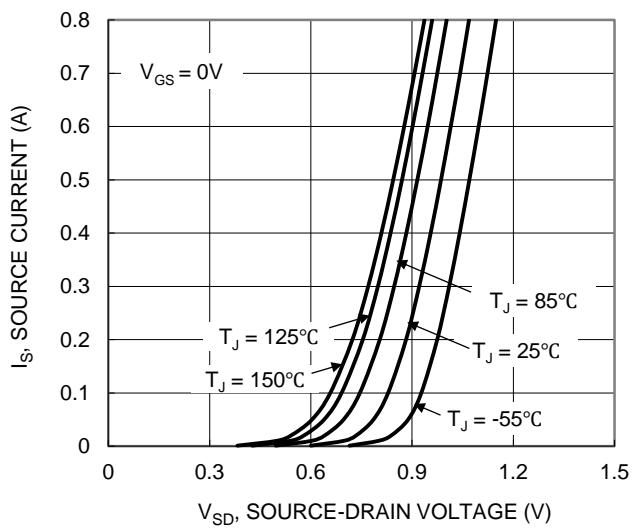
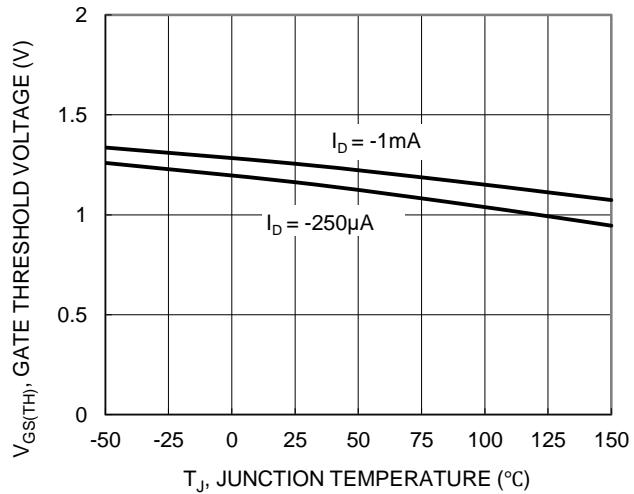
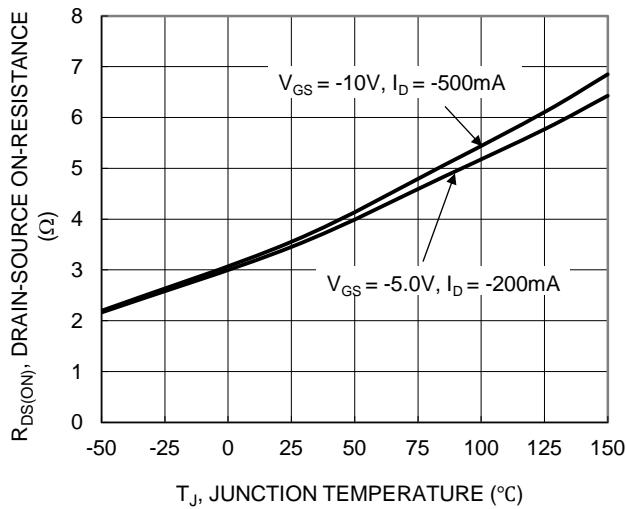


Figure 18. On-Resistance Variation with Temperature

Typical Characteristics - P-CHANNEL (Cont.)



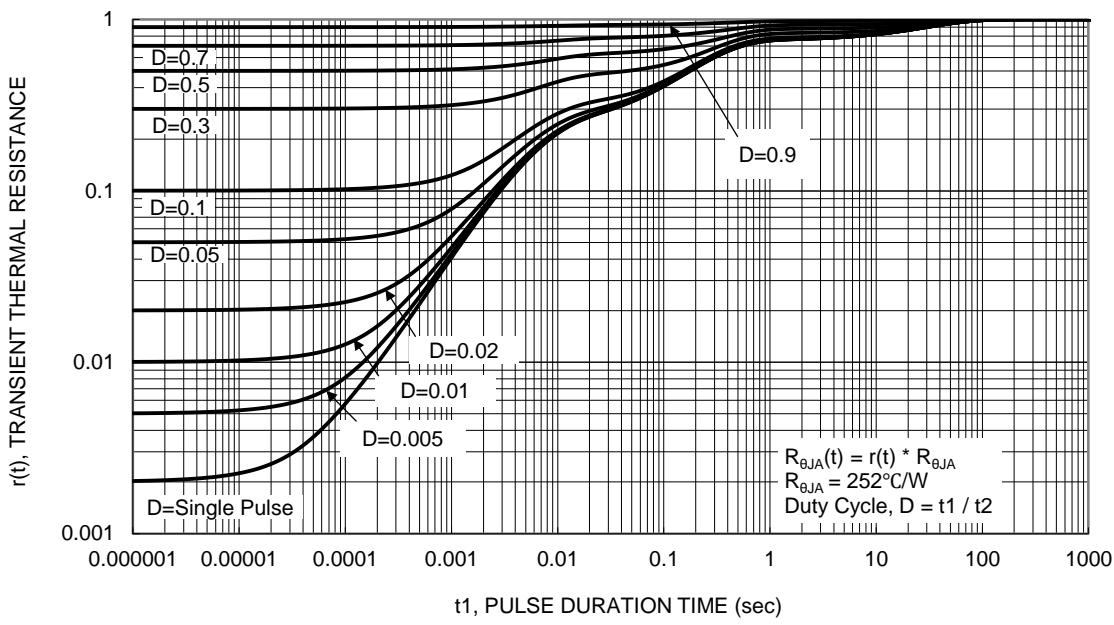


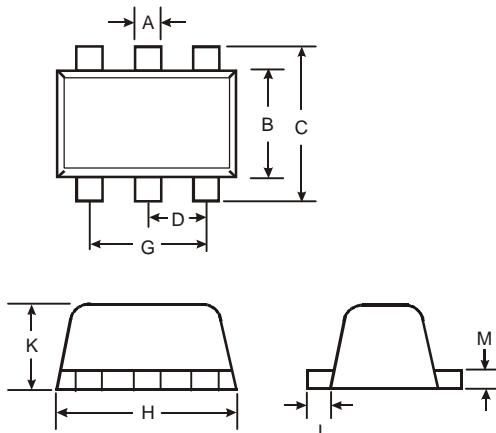
Figure 25. Transient Thermal Resistance

NOT RECOMMENDED FOR NEW DESIGN

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



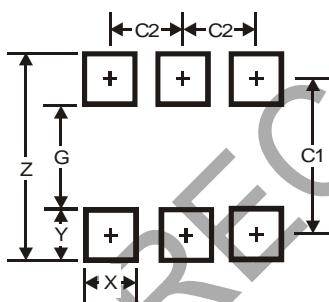
SOT563			
Dim	Min	Max	Typ
A	0.15	0.30	0.20
B	1.10	1.25	1.20
C	1.55	1.70	1.60
D	-	-	0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
K	0.55	0.60	0.60
L	0.10	0.30	0.20
M	0.10	0.18	0.11

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



Dimensions	SOT563
Z	2.2
G	1.2
X	0.375
Y	0.5
C1	1.7
C2	0.5

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